

RoHS Compliant Product  
A suffix of "-C" specifies halogen & lead-free

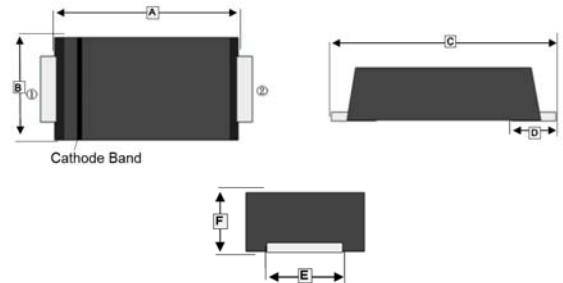
### FEATURES

- Low profile package
- Glass Passivated Chip Junction
- Low reverse current

### MECHANICAL DATA

- Case : SMAM
- Terminals: Solderable per MIL-STD-750, Method 2026
- Weight: 27 mg (Approximate)

### SMAM



### MARKING

Part Number	Marking Code	Part Number	Marking Code
SM220AM	SS24	SM2100AM	SS210
SM240AM	SS24	SM2150AM	SS215
SM260AM	SS26	SM2200AM	SS220

REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	3.20	3.70	D	1 TYP.	
B	2.40	2.80	E	1.30	1.60
C	4.40	4.90	F	0.90	1.20

### PACKAGE INFORMATION

Package	MPQ	Leader Size
SMAM	3K	7 inch

### ABSOLUTE MAXIMUM RATINGS

(Rating 25°C ambient temperature unless otherwise specified. Single phase half wave, 60Hz, resistive or inductive load.  
For capacitive load, de-rate current by 20%.)

Parameter	Symbol	Part Number						Unit
		SM 220AM	SM 240AM	SM 260AM	SM 2100AM	SM 2150AM	SM 2200AM	
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	20	40	60	100	150	200	V
Maximum RMS Voltage	$V_{RMS}$	14	28	42	70	105	140	V
Maximum DC Blocking Voltage	$V_{DC}$	20	40	60	100	150	200	V
Maximum Average Forward Rectified Current	$I_F$	2						A
Peak Forward Surge Current, 8.3ms single half sine-wave superimposed on rated load	$I_{FSM}$	50						A
Maximum Instantaneous Forward Voltage $I_F=2A @ 25^\circ C$	$V_F$	0.55		0.7	0.85	0.95		V
Maximum DC Reverse Current at Rated DC Blocking Voltage	$T_A=25^\circ C$	0.5			0.3			mA
	$T_A=100^\circ C$	10			5			
Typical Junction Capacitance <sup>1</sup>	$C_J$	160		80				pF
Typical Thermal Resistance <sup>2</sup>	$R_{\theta JA}$	80						°C/W
Operating & Storage Temperature	$T_J, T_{STG}$	-55~ 150						°C

Notes:

1. Measured at 1MHz and applied reverse voltage of 4 V D.C.
2. P.C.B. mounted with 10 X 10 x 0.2 mm copper pad areas.

**RATINGS AND CHARACTERISTIC CURVES**

Fig.1 Forward Current Derating Curve

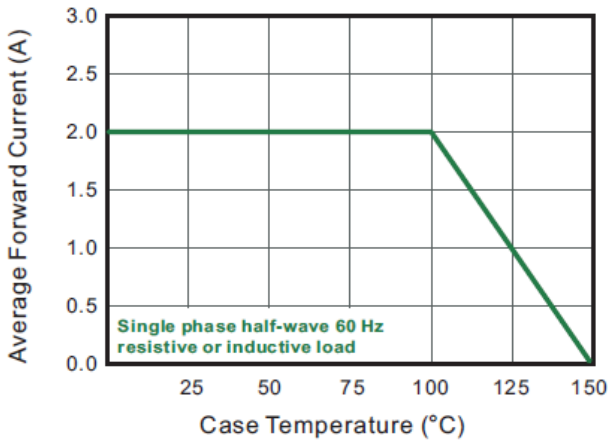


Fig.2 Typical Reverse Characteristics

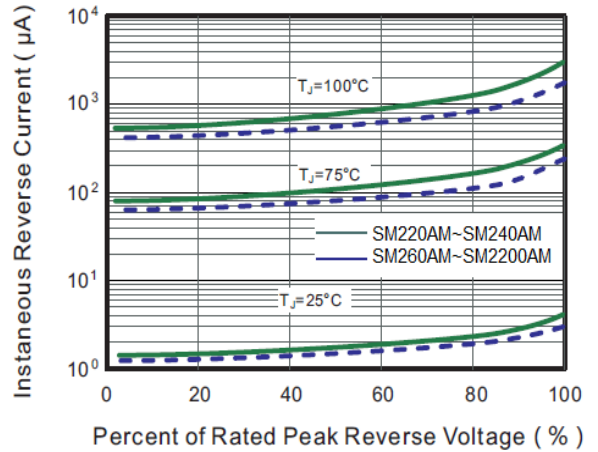


Fig.3 Typical Forward Characteristic

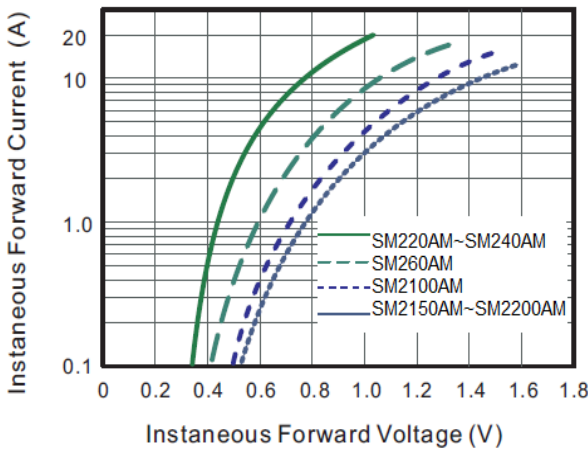


Fig.4 Typical Junction Capacitance

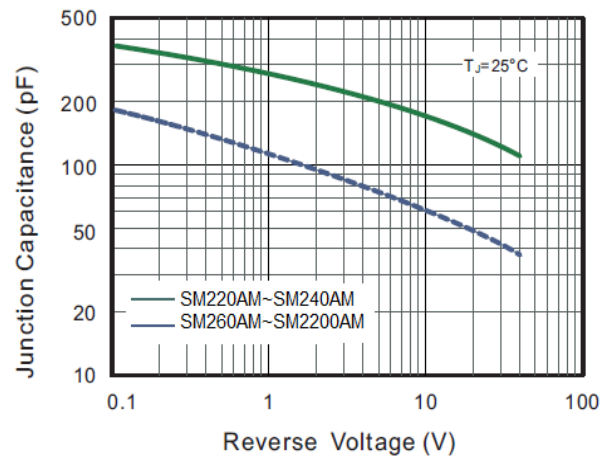


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

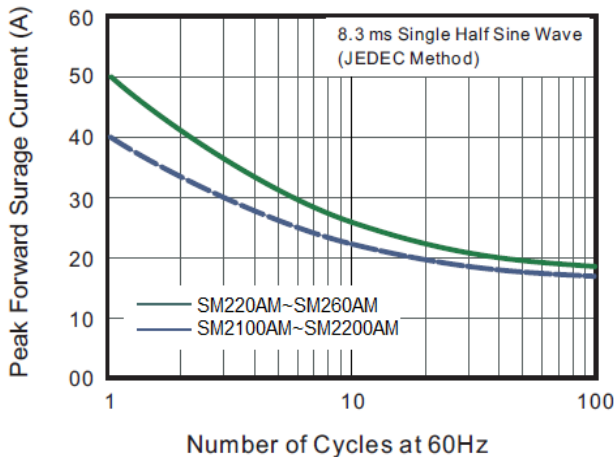


Fig.6 Typical Transient Thermal Impedance

